

RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

FEATURES

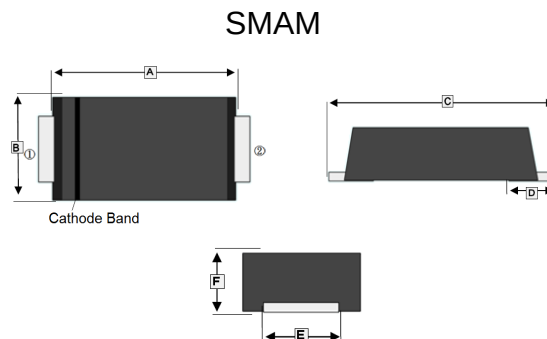
- Low profile package
- Glass Passivated Chip Junction
- Low reverse current
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case : SMAM
- Terminals: Solderable per MIL-STD-750, Method 2026
- Weight: 27 mg (Approximate)

MARKING

Part Number	Marking Code	Part Number	Marking Code
QG201AM	S2A	QG205AM	S2J
QG202AM	S2B	QG206AM	S2K
QG203AM	S2D	QG207AM	S2M
QG204AM	S2G		



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	3.30	3.70	D	0.80	1.20
B	2.40	2.70	E	1.30	1.60
C	4.40	4.90	F	0.90	1.10

PACKAGE INFORMATION

Package	MPQ	Leader Size
SMAM	3K	7 inch

ABSOLUTE MAXIMUM RATINGS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

or capacitive load, dc rate current by 20%.)

Parameter		Symbol	Part Number							Unit
			QG 201AM	QG 202AM	QG 203AM	QG 204AM	QG 205AM	QG 206AM	QG 207AM	
Maximum Repetitive Peak Reverse Voltage		V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage		V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current		I _F	2							A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load		I _{FSM}	60							A
Maximum Instantaneous Forward Voltage I _F =2A		V _F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	T _A =25℃	I _R	5							μA
	T _A =125℃		50							
Typical Junction Capacitance ¹		C _J	30							pF
Typical Thermal Resistance ²		R _{θJL}	22							℃/W
Typical Thermal Resistance ²		R _{θJC}	30							℃/W
Operating & Storage Temperature		T _J , T _{STG}	-55~ 150							℃

Notes:

1. Measured at 1 MHz and applied reverse voltage of 4 V D.C
2. P.C.B. mounted with 10 X 10 x 0.2 mm copper pad areas.

RATINGS AND CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

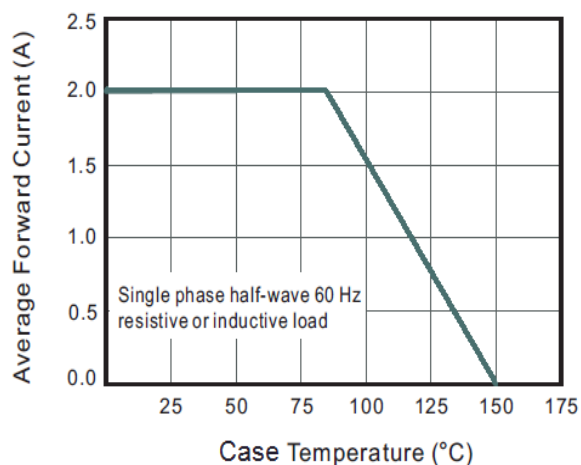


Fig.2 Typical Instantaneous Reverse Characteristics

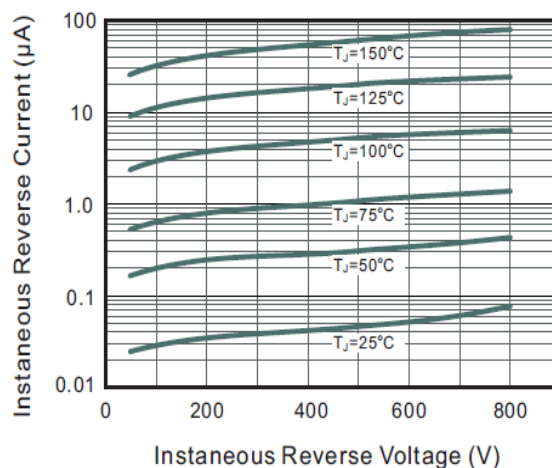


Fig.3 Typical Forward Characteristic

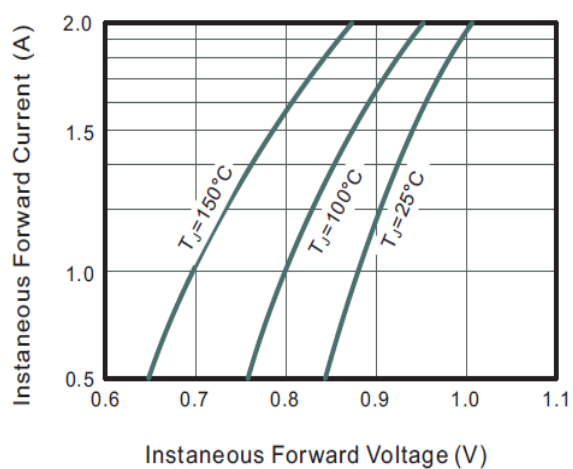


Fig.4 Typical Junction Capacitance

